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Inverter Grade Thyristors (Hockey PUK Version), 370 A



TO-200AB (A-PUK)

PRODUCT SUMMARY	PRODUCT SUMMARY				
Package	TO-200AB (A-PUK)				
Diode variation	Single SCR				
I _{T(AV)}	370 A				
V _{DRM} /V _{RRM}	1000 V, 1200 V				
V_{TM}	1.72 V				
I _{TSM} at 50 Hz	5260 A				
I _{TSM} at 60 Hz	5510 A				
I _{GT}	200 mA				
T _C /T _{hs}	55 °C				

FEATURES

- Metal case with ceramic insulator
- All diffused design
- · Center amplifying gate
- Guaranteed high dV/dt
- International standard case TO-200AB (A-PUK)
- · Guaranteed high dl/dt
- High surge current capability
- Low thermal impedance
- High speed performance
- · Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- Inverters
- Choppers
- · Induction heating
- All types of force-commutated converters

MAJOR RAT	INGS AND CHARACTERISTICS			
PARAMETER	TEST CONDITIONS	VALUES	UNITS	
		370	А	
Γ(AV) T	T _{hs}	55	°C	
1		700	А	
T(RMS)	T _{hs}	25	°C	
1	50 Hz	5260	^	
I _{TSM}	60 Hz	5510	Α	
l ² t	50 Hz	138	kA ² s	
1-1	60 Hz	126		
V _{DRM} /V _{RRM}		1000 to 1200	V	
t _q	Range	20 to 30	μs	
TJ		-40 to 125	°C	

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS							
TYPE NUMBER VOLTAGE CODE VDRM/VRRM, MAXIMUM REPETITIVE PEAK VOLTAGE V		V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$\begin{split} &I_{DRM}/I_{RRM} \text{ MAXIMUM} \\ &AT T_J = T_J \text{ MAXIMUM} \\ & \text{mA} \end{split}$				
VS-ST203CC	10	1000	1100	40			
VS-S1203CC	12	1200	1300	40			



CURRENT CARRYING CAPABILITY							
FREQUENCY	180°	el I _{TM}	180	I _{TM}	100	μs	UNITS
50 Hz	860	750	1340	1160	5620	5020	
400 Hz	840	706	1400	1220	2940	2590	A
1000 Hz	700	580	1350	1170	1750	1520	_ ^
2500 Hz	430	340	980	830	910	780	
Recovery voltage V _r	5	0	50		50		V
Voltage before turn-on V _d	V_{DRM}		V_{DRM}		V_{DRM}] V
Rise of on-state current dl/dt	50		-		-		A/µs
Heatsink temperature	40	55	40	55	40	55	°C
Equivalent values for RC circuit	47/0	0.22	47/	0.22	47/0.22		Ω/μF

ON-STATE CONDUCTION						
PARAMETER	SYMBOL		TEST CON	NDITIONS	VALUES	UNITS
Maximum average on-state current	L	180° condu	180° conduction, half sine wave		370 (140)	Α
at heatsink temperature	I _{T(AV)}	double side	(single side) co	oled	55 (85)	°C
Maximum RMS on-state current	I _{T(RMS)}	DC at 25 °C	heatsink temp	erature double side cooled	700	
		t = 10 ms	No voltage		5260	
Maximum peak, one half cycle,	L	t = 8.3 ms	reapplied		5510	Α
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		4420	- kA ² s
		t = 8.3 ms	reapplied	Sinusoidal half wave,	4630	
Maximum I ² t for fusing	l ² t	t = 10 ms	No voltage	initial $T_J = T_J$ maximum	138	
		t = 8.3 ms	reapplied		126	
Maximum i-t for fusing		t = 10 ms	100 % V _{RRM}		98	
		t = 8.3 ms	reapplied		89	
Maximum $I^2\sqrt{t}$ for fusing	I²√t	t = 0.1 to 10	ms, no voltage	e reapplied	1380	kA²√s
Maximum peak on-state voltage	V _{TM}		, T _J = T _J maxim		1.72	
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), $T_J = T_J$ maximum			V
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			1.22	
Low level value of forward slope resistance	r _{t1}	(16.7 % x π x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$), $T_J = T_J$ maximum			0.92	
High level value of forward slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			0.83	mΩ
Maximum holding current	l _Η	T _J = 25 °C,	I _T > 30 A		600	mA
Typical latching current	Ι _L	T _J = 25 °C,	V _A = 12 V, R _a =	6 Ω, I _G = 1 A	1000	IIIA



SWITCHING							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum non-repetitive rate of rise of turned on current	dl/dt	$T_J = T_J$ maximum, $V_{DRM} = Rated V_{DRM}$ $I_{TM} = 2 \times dI/dt$	1000	A/μs			
Typical delay time	t _d	T_J = 25 °C, V_{DM} = Rated V_{DRM} , I_{TM} = 50 A DC, t_p = 1 μs Resistive load, gate pulse: 10 V, 5 Ω source	0.8				
Maximum turn-off time minimum		$T_J = T_J$ maximum, $I_{TM} = 300$ A, commutating dl/dt = 20 A/ μ s	20	μs			
maximum	t _q	$V_R = 500 \text{ K}$, commutating divid = 20 Mps $V_R = 50 \text{ V}$, $t_p = 500 \text{ µs}$, dV/dt: See table in device code	30				

BLOCKING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum critical rate of rise of off-state voltage	dV/dt	T _J = T _J maximum, linear to 80 % V _{DRM} , higher value available on request	500	V/µs	
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	40	mA	

TRIGGERING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum peak gate power	P _{GM}	T _{.1} = T _{.1} maximum, f = 50 Hz, d % = 50	60	W
Maximum average gate power	P _{G(AV)}	11 = 11 maximum, 1 = 30 mz, 0.76 = 30	10	VV
Maximum peak positive gate current	I _{GM}		10	Α
Maximum peak positive gate voltage	+ V _{GM}	$T_J = T_J$ maximum, $t_p \le 5$ ms	20	- v
Maximum peak negative gate voltage	- V _{GM}		5	
Maximum DC gate currrent required to trigger	I _{GT}	T - 25 °C V - 12 V B - 6 O	200	mA
Maximum DC gate voltage required to trigger	V _{GT}	$T_J = 25 ^{\circ}\text{C}, V_A = 12 \text{V}, R_a = 6 \Omega$	3	V
Maximum DC gate current not to trigger	I _{GD}	T - T maximum rated // applied	20	mA
Maximum DC gate voltage not to trigger	V_{GD}	$T_J = T_J$ maximum, rated V_{DRM} applied	0.25	V

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum operating junction temperature range	TJ		- 40 to 125	°C	
Maximum storage temperature range	T _{Stg}		- 40 to 150		
Maximum thermal resistance in action to be stainly	В	DC operation single side cooled	0.17		
Maximum thermal resistance, junction to heatsink	R _{thJ-hs}	DC operation double side cooled	0.08	K/W	
Maying up they mal reciptored ages to be steinly	R _{thC-hs}	DC operation single side cooled	0.033	l √vv	
Maximum thermal resistance, case to heatsink		DC operation double side cooled	0.017		
Mounting force, ± 10 %			4900 (500)	N (kg)	
Approximate weight			50	g	
Case style		See dimensions - link at the end of datasheet	TO-200AB	(A-PUK)	



△R _{thJ-hs} CONDUCTION							
CONDUCTION ANGLE	SINUSOIDAL CON		ONDUCTION RECTANGULAR CONDUCTION			UNITS	
CONDOCTION ANGLE	Single Side	Double Side	Single Side	Double Side	TEST CONDITIONS	UNITS	
180°	0.015	0.017	0.011	0.011			
120°	0.018	0.019	0.019	0.019			
90°	0.024	0.024	0.026	0.026	$T_J = T_J$ maximum	K/W	
60°	0.035	0.035	0.036	0.037			
30°	0.060	0.060	0.060	0.061			

Note

Maximum Allowable Heatsink Temperature (°C)

20

0 50

The table above shows the increment of thermal resistance R_{thJ-hs} when devices operate at different conduction angles than DC

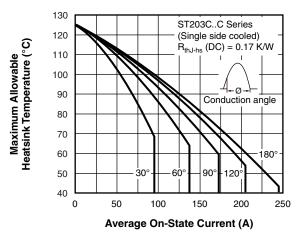


Fig. 1 - Current Ratings Characteristics

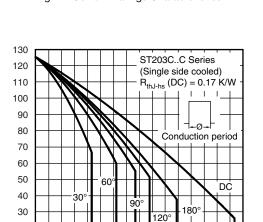


Fig. 2 - Current Ratings Characteristics

150 200 250

Average On-State Current (A)

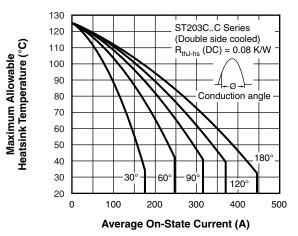


Fig. 3 - Current Ratings Characteristics

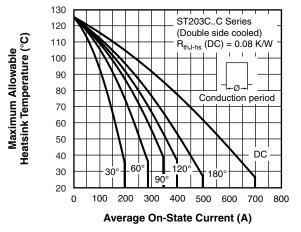


Fig. 4 - Current Ratings Characteristics



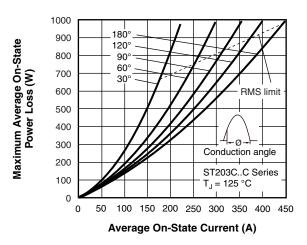


Fig. 5 - On-State Power Loss Characteristics

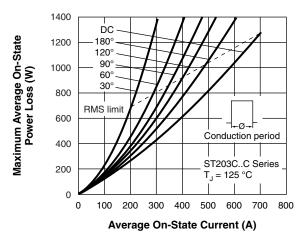


Fig. 6 - On-State Power Loss Characteristics

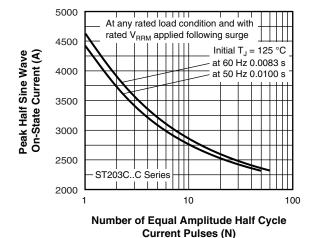


Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

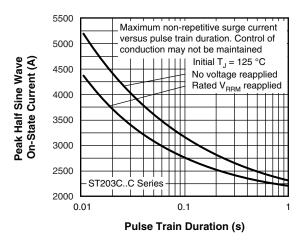


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

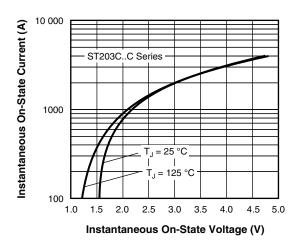


Fig. 9 - On-State Voltage Drop Characteristics

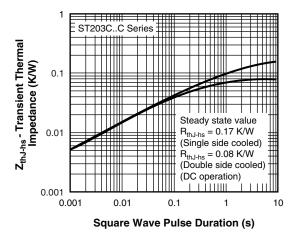


Fig. 10 - Thermal Impedance Z_{thJ-hs} Characteristics

Snubber circuit

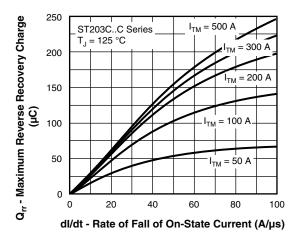


Fig. 11 - Reverse Recovered Charge Characteristics

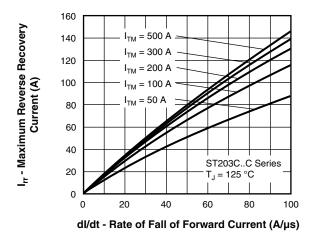
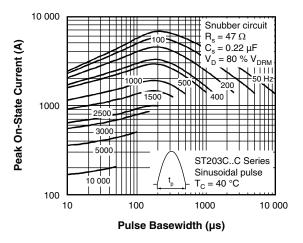


Fig. 12 - Reverse Recovery Current Characteristics



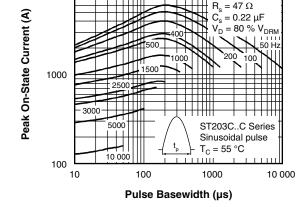
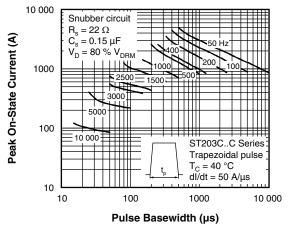


Fig. 13 - Frequency Characteristics

10 000



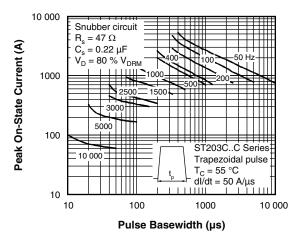
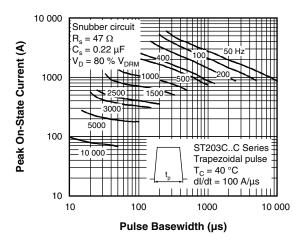


Fig. 14 - Frequency Characteristics





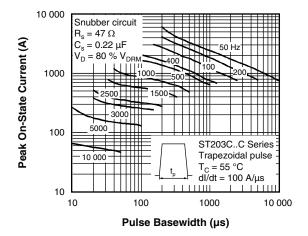
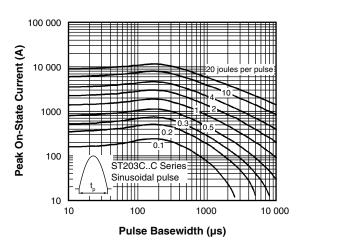


Fig. 15 - Frequency Characteristics



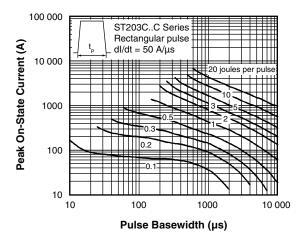


Fig. 16 - Maximum On-State Energy Power Loss Characteristics

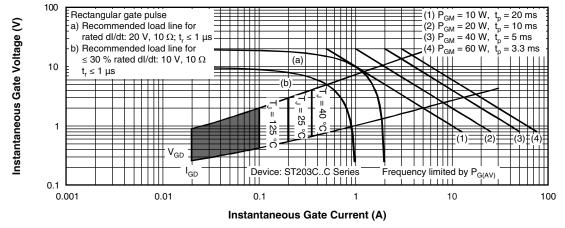
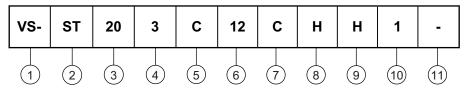


Fig. 17 - Gate Characteristics



ORDERING INFORMATION TABLE

Device code



- Vishay Semiconductors product
- Thyristor
- Essential part number
- 3 = Fast turn-off
- C = Ceramic PUK
- Voltage code x 100 = V_{RRM} (see Voltage Ratings table)
- C = PUK case TO-200AB (A-PUK)
- Reapplied dV/dt code (for t_q test condition)
- ta code -
- 0 = Eyelet terminals

(gate and auxiliary cathode unsoldered leads)

1 = Fast-on terminals

(gate and auxiliary cathode unsoldered leads)

2 = Eyelet terminals

(gate and auxiliary cathode soldered leads)

3 = Fast-on terminals

(gate and auxiliary cathode soldered leads)

- 11 Critical dV/dt:
 - None = 500 V/µs (standard value)
 - L = 1000 V/µs (special selection)

dV/dt - t _q combinations available						
	dV/dt (V/μs)	20	50	100	200	400
	20	CK	DK	EK	- FJ*	-
t,	_q (µs) 25	CJ	DJ	EJ	FJ*	-
	30	CH	DH	EH	FH	HH

* Standard part number.

All other types available only on request.

LINKS TO RELATED DOCUMENTS		
Dimensions	www.vishay.com/doc?95074	

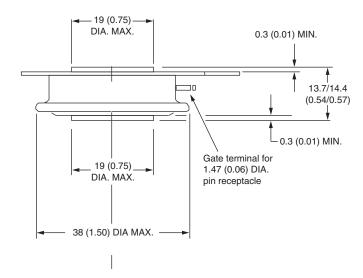


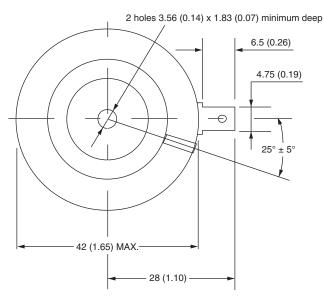
TO-200AB (A-PUK)

DIMENSIONS in millimeters (inches)

Anode to gate

Creepage distance: 7.62 (0.30) minimum Strike distance: 7.12 (0.28) minimum





Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



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